SiC Power Module

BSM300D12P2E001

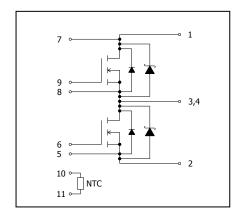
Application

- · Motor drive
- · Inverter, Converter
- · Photovoltaics, wind power generation.
- · Induction heating equipment.

Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

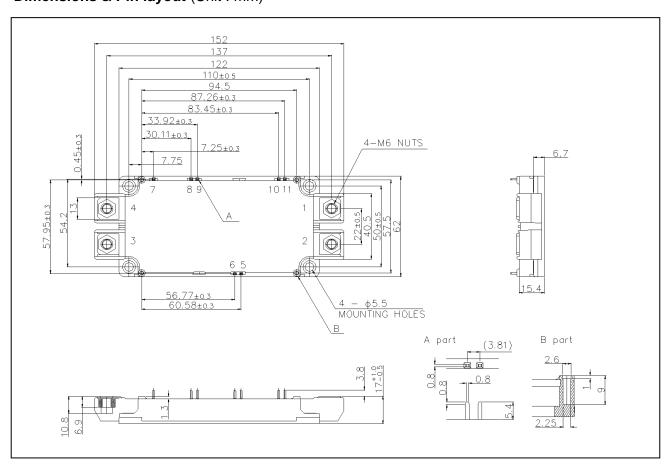
●Circuit diagram



Construction

This product is a half bridge module consisting of SiC-DMOSFET and SiC-SBD from ROHM.

●Dimensions & Pin layout (Unit : mm)

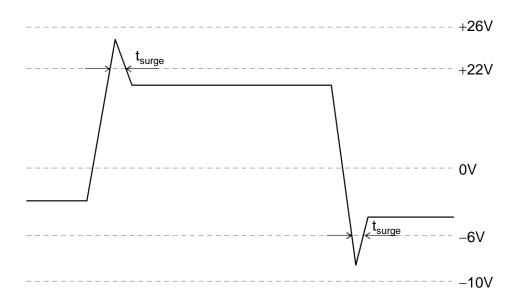


● Absolute maximum ratings (T_i = 25°C)

Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	V_{DSS}	G-S short	1200		
Gate-source voltage(+)	V_{GSS}	D-S short	22	V	
Gate-source voltage(-)	V GSS	D-3 SHOIL	-6	ľ	
G - S Voltage (t _{surge} <300nsec)	V_{GSS_surge}	D-S short	-10 to 26		
Drain current *1	I _D	DC (T _c =60°C)	300	A	
	I _{DRM}	Pulse (T _c =60°C) 1ms *2	600		
Source current *1	I _S	DC (T _c =60°C)	300		
	I _{SRM}	Pulse (Tc=60°C) 1ms *2	600		
Total power disspation *3	Ptot	T _c =25°C	1875	W	
Max Junction Temperature	T _{jmax}		175		
Operating junction temperature	T_jop		-40 to150	°C	
Storage temperature	T _{stg}		-40 to125		
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min.	2500	Vrms	
Mounting torque	_	Main Terminals : M6 screw	4.5	N·m	
		Mounting to heat shink: M5 screw	3.5		

^(*1) Case temperature (T_c) is defined on the surface of base plate just under the chips.

Example of acceptable V_{GS} waveform



^(*2) Repetition rate should be kept within the range where temperature rise if die should not exceed T_{j max}.

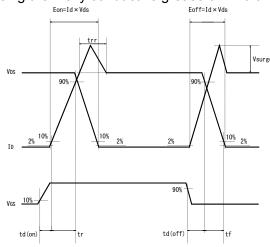
^(*3) T_j is less than 175°C

●Electrical characteristics (T_j=25°C)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Static drain-source on-state voltage	V _{DS(on)}	I _D =300A, V _{GS} =18V	T _j =25°C	-	2.2	2.9	V
			T _j =125°C	-	3.0	-	
			T _j =150°C	-	3.4	4.5	
Drain cutoff current	I _{DSS}	V _{DS} =1200V, V _{GS} =0V		-	-	3.2	mA
Source-drain voltage	V_{SD}	V _{GS} =0V, I _S =300A	T _j =25°C	-	1.6	2.1	V
			T _j =125°C		2.2	-	
			T _j =150°C	-	2.4	3.2	
		V _{GS} =18V, I _S =300A	T _j =25°C	-	1.4	-	
			T _j =125°C		1.6	-	
			T _j =150°C	-	1.7	-	
Gate-source threshold voltage	$V_{GS(th)}$	V _{DS} =10V, I _D =68mA		1.6	2.7	4.0	V
Gate-source leakage current	I _{GSS}	V _{GS} =22V, V _{DS} =0V		-	-	0.5	μΑ
		$V_{GS} = -6V, V_{DS} = 0V$		-0.5	-	-	
Switching characteristics	t _{d(on)}	V _{GS(on)} =18V, V _{GS(off)} =0V		-	80	-	ns
	t _r	V_{DS} =600 V I_{D} =300 A R_{G} =0.2 Ω inductive load		-	70	-	
	t _{rr}			ı	50	-	
	t _{d(off)}			1	250	-	
	t _f			-	65	-	
Input capacitance	Ciss	V _{DS} =10V, V _{GS} =0V,100kHz		ı	35	-	nF
Gate Registance	R_{Gint}	T _j =25°C		•	1.6	-	Ω
NTC Rated Resistance	R25				5.0		kΩ
NTC B Value	B50/25				3370		K
Stray Inductance	Ls				13	-	nΗ
Creepage Distance	-	Terminal to heat sink			14.5	-	mm
		Terminal to terminal			15.0	-	mm
Clearance Distance	-	Terminal to heat sink			12.0	-	mm
		Terminal to terminal			9.0	-	mm
Junction-to-case thermal resistance		DMOS (1/2 module) *4		-	-	80.0	K/W
		SBD (1/2 module) *4		•	-	0.11	
Case-to-heat sink	R _{th} (c-f)	Case to heat sink, per 1 module,			0.035	-	
Thermal resistance	i V _{th} (O ³ I)	Thermal grease appied *5			0.000		

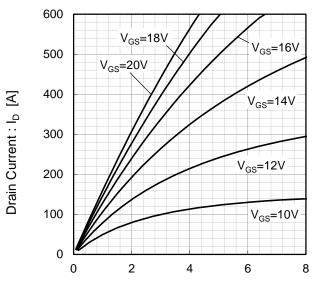
^(*4) Measurement of T_c is to be done at the point just beneath the chip.

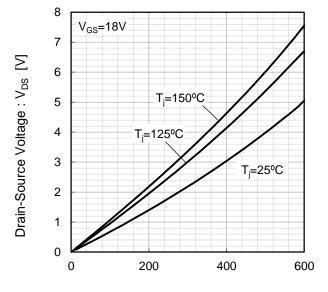
Waveform for switching test



^(*5) Typical value is measured by using thermally conductive grease of λ =0.9W/(m·K).

Fig.1 Typical Output Characteristics [T_i=25°C] Fig.2 Drain-Source Voltage vs. Drain Current





Drain-Source Voltage : V_{DS} [V]

Drain Current : I_D [A]

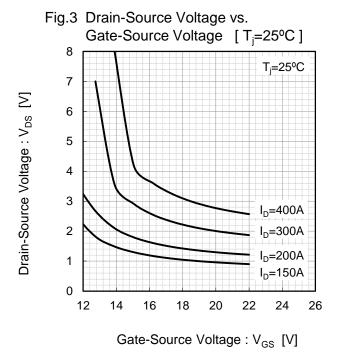
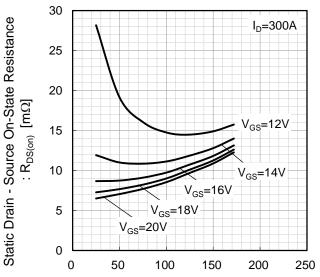
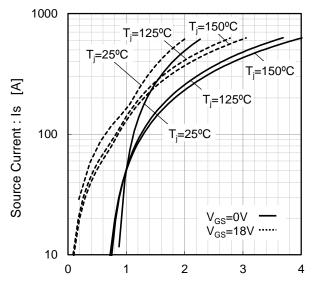


Fig.4 Static Drain - Source On-State Resistance vs. Junction Temperature



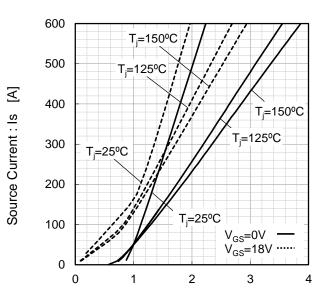
Junction Temperature : T_i [°C]

Fig.5 Forward characteristic of Diode



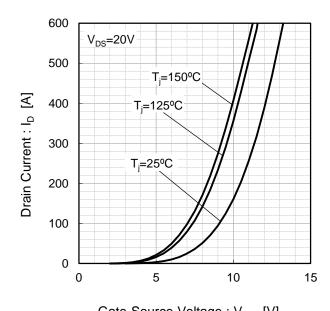
Source-Drain Voltage: V_{SD} [V]

Fig.6 Forward characteristic of Diode



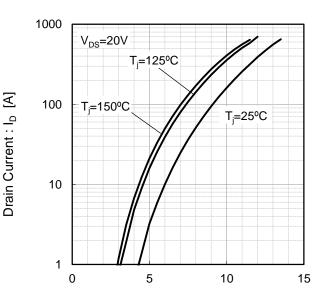
Source-Drain Voltage: V_{SD} [V]

Fig.7 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage : V_{GS} [V]

Fig.8 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage : V_{GS} [V]

Fig.9 Switching Characteristics [T_i=25°C]

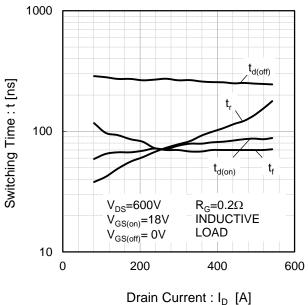
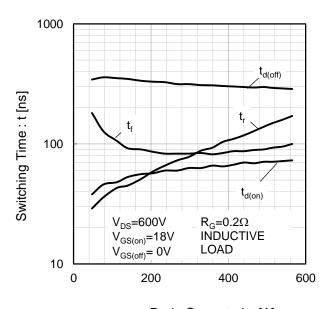
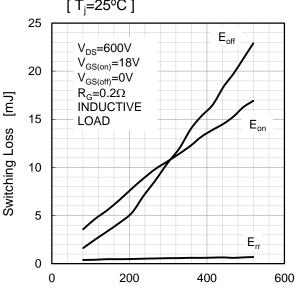


Fig.10 Switching Characteristics [T_i=150°C]



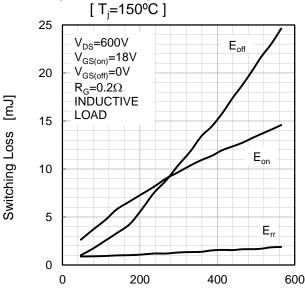
ent : I_D [A] Drain Current : I_D [A]

Fig.11 Switching Loss vs. Drain Current [T_i=25°C]

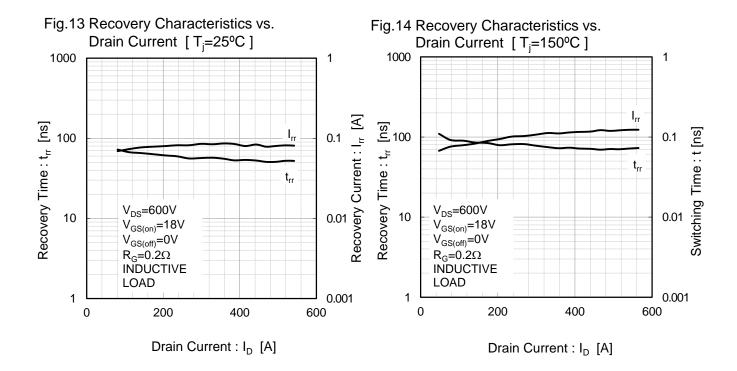


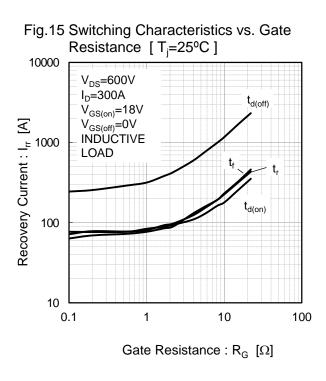
Drain Current : I_D [A]

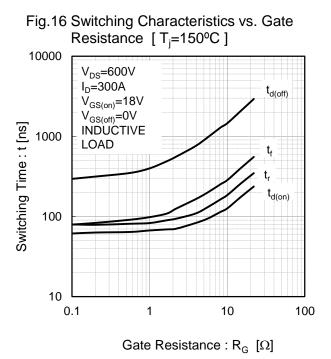
Fig.12 Switching Loss vs. Drain Current



Drain Current : I_D [A]







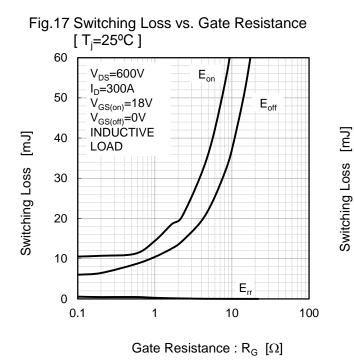
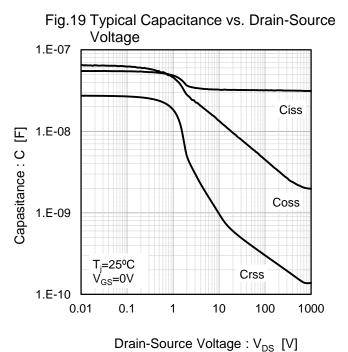
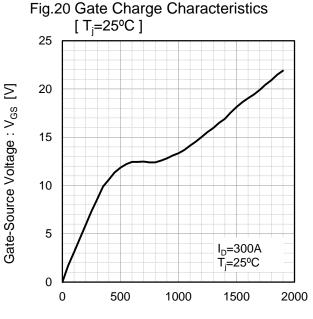


Fig.18 Switching Loss vs. Gate Resistance $[T_i=150^{\circ}C]$ 60 $V_{DS} = 600V$ $I_{D} = 300A$ 50 $V_{GS(on)}=18V$ $V_{GS(off)}=0V$ INDUCTIVE 40 LOAD 30 $\mathsf{E}_{\mathsf{off}}$ 20 E_{on} 10 E_{rr} 0 10 100 0.1

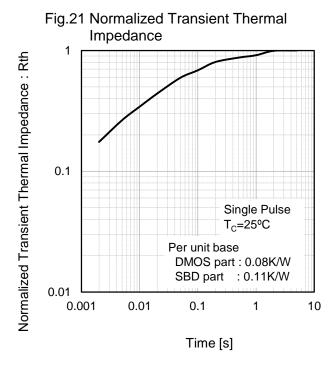
Gate Resistance : R_G [Ω]







Total Gate charge : Qg [nC]



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